

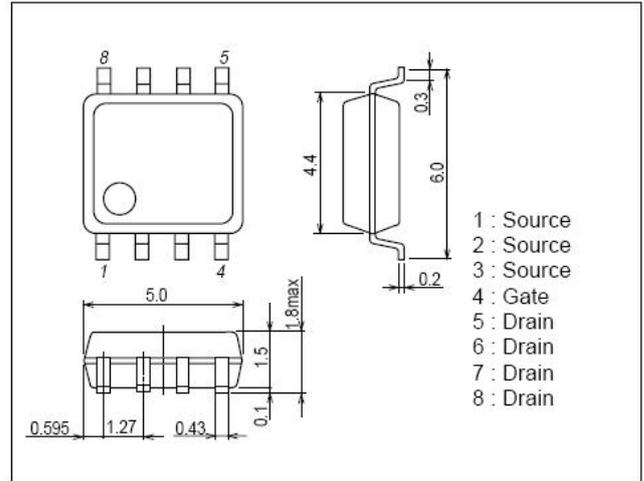
### Features

- Low On resistance.
- -4.5V drive.
- RoHS compliant.



### Package Dimensions

unit : mm  
SOP-8



### Specifications

#### Absolute Maximum Ratings at T<sub>a</sub>=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V <sub>DSS</sub>		-30	V
Gate-to-Source Voltage	V <sub>GSS</sub>		+20	V
Drain Current (DC)	I <sub>D</sub>		-9.3	A
Drain Current (Pulse)	I <sub>DP</sub>	PW≤10uS, duty cycle≤1%	-37	A
Allowable Power Dissipation	P <sub>D</sub>	Mounted on a ceramic board (1000mm <sup>2</sup> ×0.8mm) 1unit	3.1	W
Total Dissipation	P <sub>T</sub>	Mounted on a ceramic board (1000mm <sup>2</sup> ×0.8mm)	2	W
Channel Temperature	T <sub>ch</sub>		150	°C
Storage Temperature	T <sub>stg</sub>		-55~+150	°C

#### Electrical Characteristics at T<sub>a</sub>=25°C

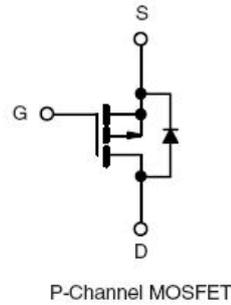
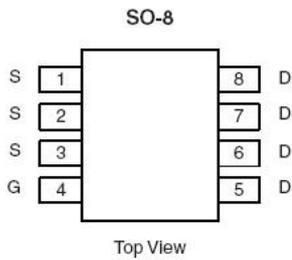
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	I <sub>D</sub> =-250uA, V <sub>GS</sub> =0V	-30			V
Zero-Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V			-10	uA
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =-250uA	-1.3	-1.8	-2.3	V
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =-5V, I <sub>D</sub> =-10A		24		S
Static Drain-to-Source On-State Resistance	R <sub>DS(ON)</sub>	I <sub>D</sub> =-9.3A, V <sub>GS</sub> =-10V		23	28	mΩ
	R <sub>DS(ON)</sub>	I <sub>D</sub> =-4A, V <sub>GS</sub> =-4.5V		32	38	mΩ
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V, f=1MHz		840		pF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V, f=1MHz		150		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V, f=1MHz		110		pF

# Si4310

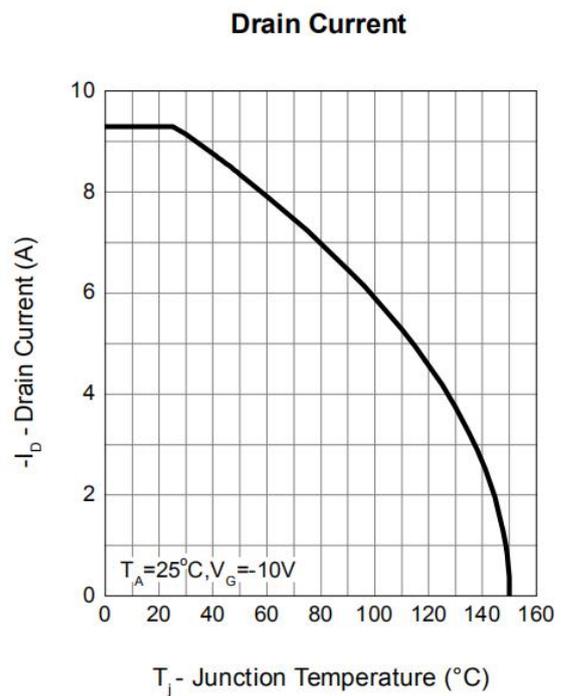
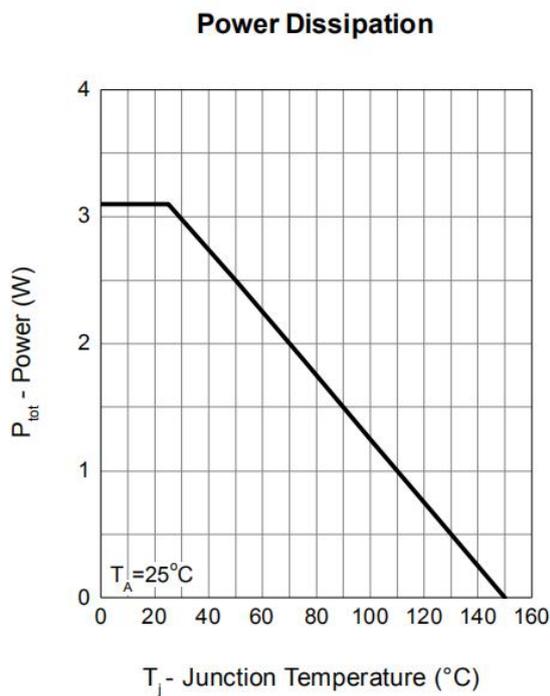
## Electrical Characteristics at $T_a=25^{\circ}\text{C}$ (Continued)

Parameter	Symbol	Conditions	Ratings			Unit
			min	Typ	max	
Turn-on Delay Time	$t_{d(on)}$	$V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, R_L=15\Omega,$ $R_{GEN}=6\Omega$		7.5		nS
Rise Time	$t_r$			8		nS
Turn-off Delay Time	$t_{d(off)}$			37		nS
Fall Time	$t_f$			16		nS
Total Gate Charge	$Q_g$	$V_{DS}=-15\text{V}, V_{GS}=-10\text{V}, I_D=-9.3\text{A}$		18		nC
Gate-to-Source Charge	$Q_{gs}$			3		nC
Gate-to-Drain "Miller" Charge	$Q_{gd}$			4		nC
Diode Forward Voltage	$V_{SD}$	$I_S=-2.1\text{A}, V_{GS}=0\text{V}$		-0.8	-1.2	V

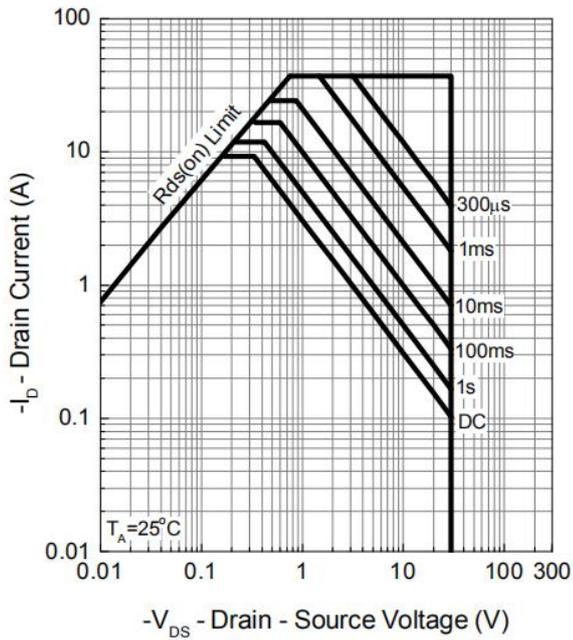
## Pin Description



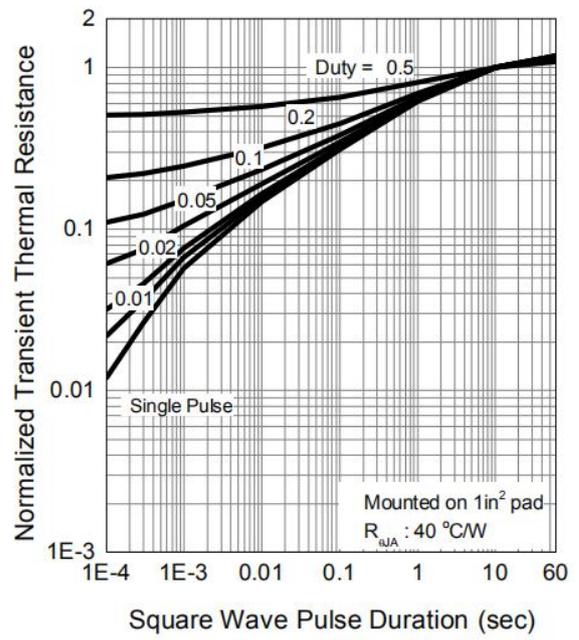
## Typical Characteristics at $T_a=25^{\circ}\text{C}$



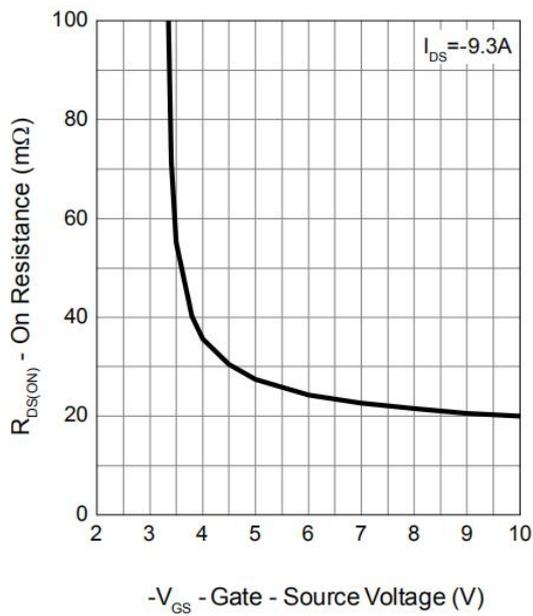
Safe Operation Area



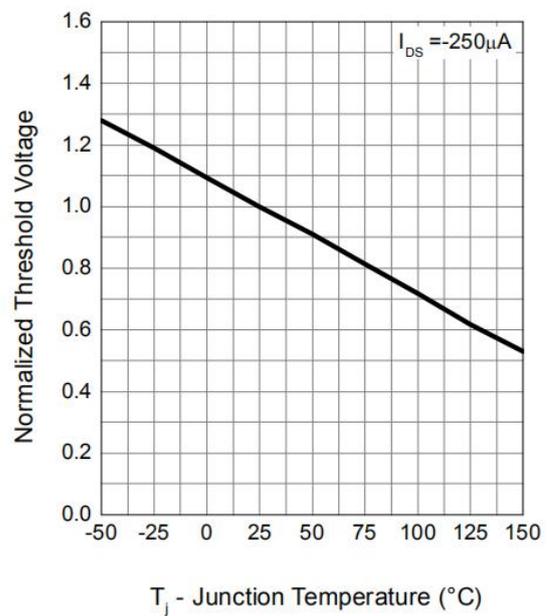
Thermal Transient Impedance



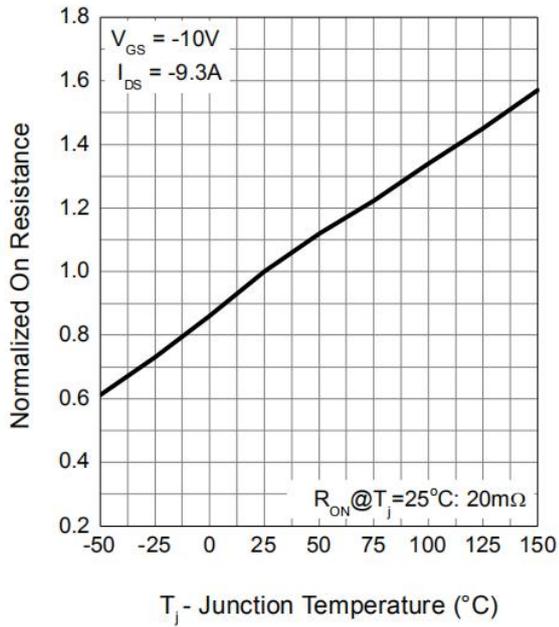
Gate-Source On Resistance



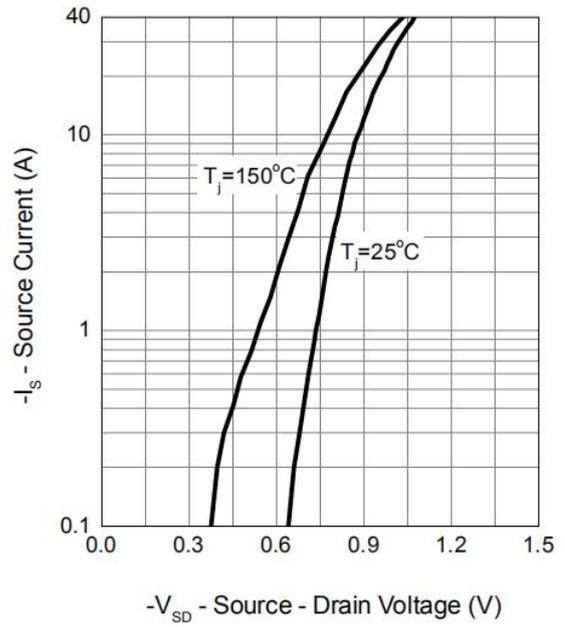
Gate Threshold Voltage



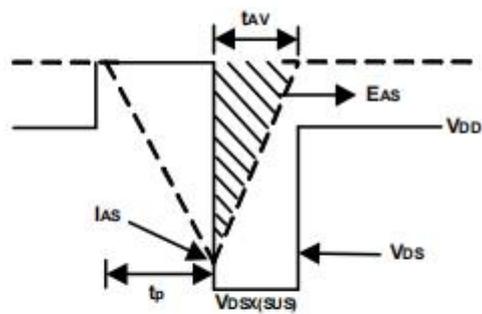
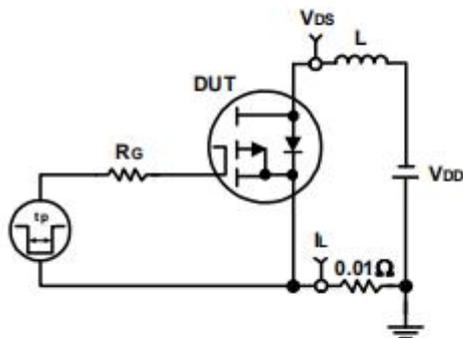
Drain-Source On Resistance



Source-Drain Diode Forward



### Avalanche Test Circuit and Waveforms



## Switching Time Test Circuit and Waveforms

